N-Channel JFET

MMBFJ110

Features

- This Device is Designed for Digital Switching Applications where Very Low On Resistance is Mandatory
- Sourced from Process 58
- This is a Pb–Free Device

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Symbol	Parameter	Value	Unit
V _{DG}	Drain-Gate Voltage	25	V
V _{GS}	Gate-Source Voltage	-25	V
I _{GF}	Forward Gate Current	10	mA
TJ	Junction Temperature	150	°C
T _J , T _{STG}	Storage Temperature Range	-55 to 150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. These ratings are based on a maximum junction temperature of 150°C.

2. These are steady-state limits. ON Semiconductor should be consulted on applications involving pulsed or low-duty-cycle operations.

THERMAL CHARACTERISTICS ($T_A = 25^{\circ}C$ unless otherwise specified) (Note 3)

Symbol	Parameter	Max	Unit
PD	Total Device Dissipation	460	mW
	Derate Above 25°C	3.68	mW/°C
R _{0JA}	Thermal Resistance, Junction-to-Ambient	270	°C/W

 Device mounted on FR-4 PCB 36 mm x 18 mm x 1.5 mm; mounting pad for the collector lead minimum 6 cm².



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MARKING DIAGRAM



110 = Specific Device Code

&Y = Year Coding &G = Weekly Date Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 4 of this data sheet.

MMBFJ110

ELECTRICAL CHARACTERISTICS (T_J = 25° C unless otherwise noted)

Symbol	Parameter	Test Condition	Min	Max	Unit	
DFF CHARACTERISTICS						
V _{(BR)GSS}	Gate-Source Breakdown Voltage	$I_{G} = -10 \ \mu A, \ V_{DS} = 0$	-25	-	V	
I _{GSS}	Gate Reverse Current	$V_{GS} = -15 \text{ V}, V_{DS} = 0$	-	-3.0	nA	
		V_{GS} = -15 V, V_{DS} = 0, T_A = 100°C	-	-200		
V _{GS} (off)	Gate-Source Cut-Off Voltage	V _{DS} = 15 V, I _D = 10 nA	-0.5	-4.0	V	
ON CHARACTERISTICS						
I _{DSS}	Zero-Gate Voltage Drain Current (Note 4)	$V_{DS} = 15 \text{ V}, V_{GS} = 0$	10	-	mA	
r _{DS} (on)	Drain-Source On Resistance	$V_{DS} \leq 0.1$ V, $V_{GS} = 0$	-	18	Ω	
SMALL SIGNAL CHARACTERISTICS						

C _{dg} (on) C _{sg} (on)	Drain-Gate & Source-Gate On Capacitance	V_{DS} = 0, V_{GS} = 0, f = 1.0 MHz	-	85	pF
C _{dg} (off) C _{sg} (off)	Drain-Gate & Source-Gate Off Capacitance	V _{DS} = 0, V _{GS} = -10 V, f = 1.0 MHz	-	15	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse test: pulse width \leq 300 μ s, duty cycle \leq 2%.



TYPICAL PERFORMANCE CHARACTERISTICS

Figure 1. Common Drain-Source

MMBFJ110

TYPICAL PERFORMANCE CHARACTERISTICS (continued)



MMBFJ110

TYPICAL PERFORMANCE CHARACTERISTICS (continued)





Figure 10. Power Dissipation vs. Ambient Temperature

ORDERING INFORMATION

Part Number	Top Mark	Package	Shipping [†]
MMBFJ108	110	SSOT 3L (Pb-Free)	3000 / Tape & Reel

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

SUPERSOT is trademark of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries.

MECHANICAL CASE OUTLINE PACKAGE DIMENSIONS



SOT-23/SUPERSOT [™] -23, 3 LEAD, 1.4x2.9 CASE 527AG ISSUE A

DATE 09 DEC 2019



	ASME Y	14.5M, 2009	•			
2. ALL DIMENSIONS ARE IN MILLIMETERS						
5.	MOLDE	IONS ARE I	TIF BAR FX	TRUSIONS		
	DIM	MIN.	NOM.	MAX.		
	A	0.85	0.95	1.12		
	A1	0.00	0.05	0.10		
	b	0.370	0.435	0.508		
	с	0.085	0.150	0.180		
	D	2.80	2.92	3.04		
	Е	2.31	2.51	2.71		
			4.40			

NOTES: UNLESS OTHERWISE SPECIFIED

1. DIMENSIONING AND TOLERANCING PER









SEE DETAIL A



LAND PATTERN RECOMMENDATION* *FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

*This information is generic. Please refer to device data sheet for actual part marking. Pb–Free indicator, "G" or microdot "●", may or may not be present. Some products may not follow the Generic Marking.

MAR	GENERIC	; GRAM*
	XXXM=]

XXX	= Specific Device Code
М	= Month Code
	– Ph_Free Package

DESCRIPTION: SOT-23/SUPERSOT-23, 3 LEAD, 1.4X2.9

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